



Alvium 1800 U-040c

- IMX287 CMOS sensor
- ALVIUM image processing
- USB3 Vision
- Various hardware options

Hardware option: Open Housing S-Mount Standard

Alvium 1800 U – Your entry into high-performance imaging

Industrial USB cameras with attractive price-performance ratio

Alvium 1800 U-040 with Sony IMX287 runs 494.0 frames per second at 0.4 MP resolution.

Alvium 1800 U is your entry into high-performance imaging with ALVIUM® Technology for industrial applications. Equipped with the newest generation of sensors, these small and lightweight cameras deliver high image quality and frame rates at the best price-performance ratio. With its USB3 Vision compliant interface and industrial-grade hardware, it is your workhorse for different machine vision applications whether it is on a PC-based or an embedded system.

Easy software integration with **Vimba X** and compatibility to the most popular third party image-processing libraries.

In addition to lens mount and housing options, see **Customization and OEM Solutions webpage** for additional options.

Specifications

Product code	14174
Interface	USB3 Vision
Resolution	728 (H) × 544 (V)
Spectral range	300 to 1100 nm
Sensor	Sony IMX287
Sensor type	CMOS
Shutter mode	GS (Global shutter)
Sensor size	Type 1/2.9
Pixel size	6.9 µm × 6.9 µm
Lens mount	S-Mount
Max. frame rate at full resolution	494 fps at ≥ 250 MByte/s, Mono8
ADC	12 Bit
Image buffer (RAM)	256 KByte
Non-volatile memory (Flash)	1024 KByte

Imaging performance

Imaging performance data is based on the evaluation methods in the EMVA 1288 Release 3.1 standard for characterization of image sensors and cameras. Measurements are typical values for monochrome models measured without optical filter.

Quantum efficiency at 529 nm	64 %
Temporal dark noise	3.2 e ⁻
Saturation capacity	20800 e ⁻
Dynamic range	74 dB
Absolute sensitivity threshold	4.0 e ⁻

Output

Bit depth	8-bit, 10-bit, 12-bit; Adaptive (10-bit, 12-bit)
Monochrome pixel formats	Mono8, Mono10, Mono10p, Mono12, Mono12p
YUV color pixel formats	YCbCr411_8_CbYYCrYY, YCbCr422_8_CbYCrY, YCbCr8_CbYCr
RGB color pixel formats	RGB8 (default), BGR8

Raw color pixel formats (Bayer)

BayerRG8, BayerRG10, BayerRG10p, BayerRG12, BayerRG12p

General purpose inputs/outputs (GPIOs)

TTL I/Os

4 programmable GPIOs

Operating conditions/dimensions

Operating temperature -20 °C to +65 °C (housing)

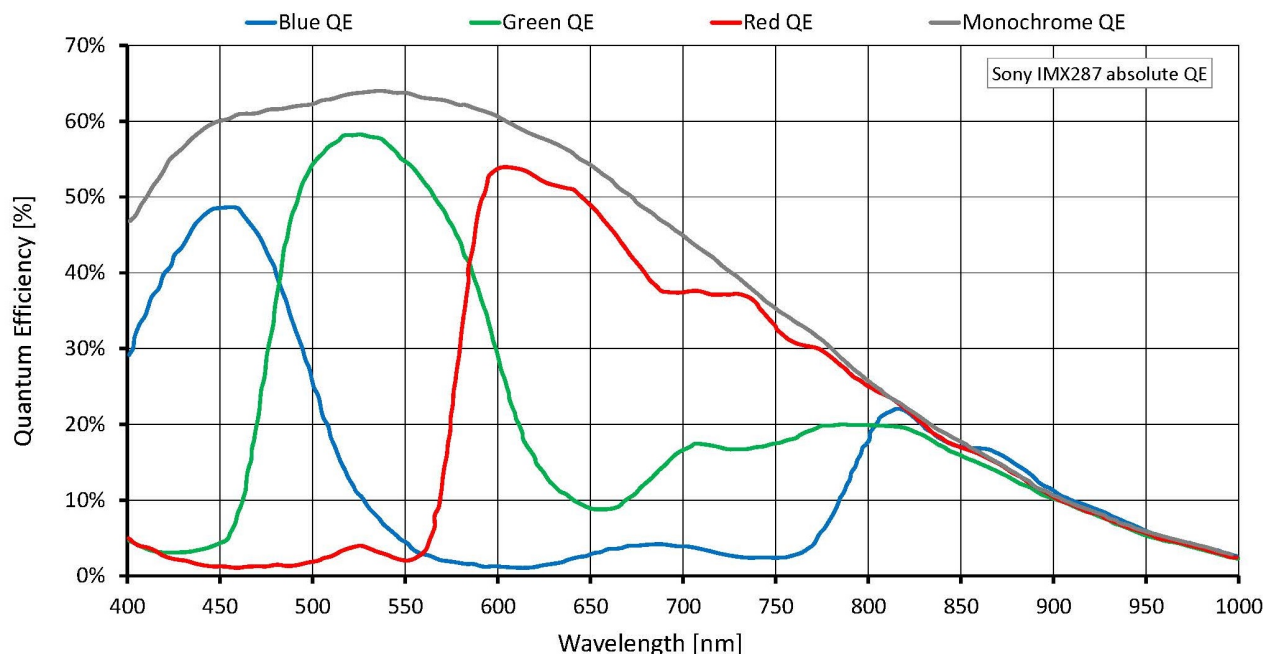
Power requirements (DC) Power over USB 3.1 Gen 1 | External power 5.0 V

Power consumption USB power: 1.9 W (typical) | Ext. power: 2.1 W (typical)

Mass 45 g

Body dimensions (L × W × H in mm) 25 × 29 × 29

Quantum efficiency



Features

Image control: Auto

- Auto exposure
- Auto gain
- Auto white balance (color models)

Image control: Other

- Adaptive noise correction
- Binning (digital)
- Black level
- Color transformation (incl. hue, saturation; color models)
- Contrast
- Custom convolution
- De-Bayering up to 5×5 (color models)
- DPC (defect pixel correction)
- FPNC (fixed pattern noise correction)
- Gamma
- Lens shading correction
- LUT (look-up table)
- Multiple ROIs (regions of interest)
- Reverse X/Y
- ROI (region of interest)
- Sharpness/Blur

Camera control

- Acquisition frame rate
- Bandwidth control
- Counters and timers
- Event channel
- Firmware update in the field
- I/O and trigger control
- Image chunk data
- Power Saving Mode
- Readout modes (SensorBitDepth)
- Sequencer
- Serial I/Os
- Temperature monitoring
- User sets

Technical drawings of the M200 camera module showing front, side, and top views with dimensions.

Front View: Shows a square module with a central lens. Dimensions include a total width of $29.35^{+0.20}_{-0.05}$ mm and a mounting hole pitch of 24 ± 0.1 mm. The mounting is labeled "S-Mount (M12 x 0.5)".

Side View (Left): Shows the module's profile. Dimensions include a total height of 20 ± 0.1 mm, a lens diameter of 8 ± 0.1 mm, and a mounting flange height of 13.2 mm. A note indicates a "Draft angle of 1deg on both sides".

Side View (Right): Shows the module's profile from the opposite side. Dimensions include a total height of $20.89^{+0.3}_{-0.1}$ mm, a mounting flange height of 13 mm, and a base thickness of 2.9 mm. A note indicates a "Draft angle of 1deg on both sides".

Top View: Shows the module's top surface. Dimensions include a total width of $25.3^{+0.5}_{-0.3}$ mm (noting "(Depends on sensor)"), a mounting hole pitch of 16.8 ± 0.1 mm, and a mounting flange height of 13.2 mm. A note indicates a "Draft angle of 1deg on both sides".

Bottom View: Shows the module's bottom surface. Dimensions include a total width of $25.3^{+0.5}_{-0.3}$ mm (noting "(Depends on sensor)"), a mounting hole pitch of 16.8 ± 0.1 mm, and a mounting flange height of 13.2 mm. A note indicates a "Draft angle of 1deg on both sides".

Isometric View: A 3D perspective view of the module showing its overall shape and mounting features.